## 16-BIT FIXED-POINT DIGITAL SIGNAL PROCESSOR

## DESCRIPTION

The $\mu \mathrm{PD} 77115$ and $\mu \mathrm{PD} 77115 \mathrm{~A}$ are 16-bit fixed-point digital signal processors (DSP).
The $\mu \mathrm{PD} 77115$ and $\mu \mathrm{PD} 77115 \mathrm{~A}$ are RAM based DSP and have the specific circuit for audio application.
Unless otherwise specified, the $\mu$ PD77115 refers to $\mu$ PD77115 and 77115A.

For details of the functions of the $\mu$ PD77115, refer to the following User's Manuals:
$\mu$ PD77111 Family User's Manual - Architecture : U14623E
$\mu$ PD77016 Family User's Manual - Instructions : U13116E

## FEATURES

- Instruction cycle (operating clock)
- Memory
- Internal instruction RAM
- Internal data RAM
- Peripherals
- Audio serial interface
- Secure Digital (SD) card interface
- 16-bit timer
- 16-bit host interface
- 8-bit port
- Supply voltage
- DSP core voltage
2.0 to 2.7 V (MAX. operation speed 50 MHz )
2.3 to 2.7 V (MAX. operation speed 75 MHz )
- I/O pin voltage
2.7 to 3.6 V
- Power consumption TYP. $50 \mathrm{~mW}(2.0 \mathrm{~V}, 50 \mathrm{MHz}$ operation)


## ORDERING INFORMATION

|  | Part Number | Package |
| :---: | :---: | :---: |
| $\star$ | $\mu$ PD77115F1-CN6 | 80-pin plastic FBGA ( $9 \times 9$ ) |
|  | $\mu$ PD77115GK-9EU | 80-pin plastic TQFP (fine pitch) $(12 \times 12)$ |
| $\star$ | $\mu \mathrm{PD} 77115 \mathrm{AF} 1-\mathrm{xxx}-\mathrm{CN} 6$ | 80-pin plastic FBGA $(9 \times 9)$ |
|  | Remark xxx indicates ROM code suffix. |  |

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## FUNCTION PIN GROUPS



Remark The P4 to P7 pins are multiplexed with PLL0 to PLL3 pins.

* DSP FUNCTION LIST

| Item |  | $\mu$ PD77110 | $\mu$ PD77111 | $\mu$ PD77112 | $\mu$ PD77113A | $\mu$ PD77114 | $\mu$ PD77115,77115A | $\mu$ PD77210 | $\mu$ PD77213 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Memory space (words $\times$ bits) | Int. instruction RAM | $35.5 \mathrm{~K} \times 32$ | $1 \mathrm{~K} \times 32$ |  | $3.5 \mathrm{~K} \times 32$ |  | $11.5 \mathrm{~K} \times 32$ | $31.5 \mathrm{~K} \times 32$ | $15.5 \mathrm{~K} \times 32$ |
|  | Int. instruction ROM | None | $31.75 \mathrm{~K} \times 32$ |  | $48 \mathrm{~K} \times 32$ |  | None |  | $64 \mathrm{~K} \times 32$ |
|  | Data RAM (XY memory) | $24 \mathrm{~K} \times 16$ each | $3 \mathrm{~K} \times 16$ each |  | $16 \mathrm{~K} \times 16$ each |  | $16 \mathrm{~K} \times 16$ each | $30 \mathrm{~K} \times 16$ each | $18 \mathrm{~K} \times 16$ each |
|  | Data ROM (XY memory) | None | $16 \mathrm{~K} \times 16$ each |  | $32 \mathrm{~K} \times 16$ each |  | None |  | $32 \mathrm{~K} \times 16$ each |
|  | Ext. instruction | None |  |  |  |  |  |  |  |
|  | Ext. data memory (XY memory) | $32 \mathrm{~K} \times 16$ each | None | $16 \mathrm{~K} \times 16$ each | None | $8 \mathrm{~K} \times 16$ each | None | $1 \mathrm{M} \times 16$ | $\begin{gathered} 1 \mathrm{M} \times 16(8 \mathrm{~K} \times \\ 16, \text { using SD I/F) } \end{gathered}$ |
| Instruction cycle (at maximum operating speed) |  | 15.3 ns <br> ( 65 MHz ) | 13.3 ns <br> ( 75 MHz ) |  |  |  |  | $\begin{gathered} 6.25 \mathrm{~ns} \\ (160 \mathrm{MHz}) \end{gathered}$ | $\begin{gathered} 8.33 \mathrm{~ns} \\ (120 \mathrm{MHz}) \end{gathered}$ |
| Multiple |  | $\begin{aligned} & \text { Integer multiple } \\ & \quad \text { of } \times 1 \text { to } 8 \\ & \text { (external pin) } \end{aligned}$ | Integer multiple of $\times 1$ to 16 (mask option) |  |  |  | Integer multiple <br> of $\times 1$ to 16 <br> (external pin) | Integer multiple of $\times 10$ to 64 (external pin) |  |
| Peripheral | Serial interface | 2 channels (speech CODEC) |  |  |  |  | 1 channel (audio CODEC) | 2 channels (time-division, audio) |  |
|  | Host interface | 8 -bit bus |  |  |  |  | 16-bit bus |  |  |
|  | General-purpose <br> port (I/O <br> programmable) | 4 bits |  |  |  |  | 8 bits | 16 bits (some are alternative with host) |  |
|  | Timer | None |  |  |  |  | 1 channel (16-bit resolution) | 2 channels (16-bit resolution) |  |
|  | Others | - | - | - | - | - | SD card I/F | - | SD card I/F |
| Supply voltage |  | $\begin{gathered} \text { DSP core: } 2.5 \mathrm{~V} \\ \text { I/O pins: } 3 \mathrm{~V} \end{gathered}$ |  |  |  |  |  | $\begin{gathered} \text { DSP core: } 1.5 \mathrm{~V} \\ \text { I/O pins: } 3 \mathrm{~V} \end{gathered}$ |  |
| Package |  | 100-pin TQFP | 80-pin TQFP <br> 80-pin FBGA | 100-pin TQFP | 80-pin FBGA | 100-pin TQFP | 80-pin TQFP <br> 80-pin FBGA | 161-pin FBGA <br> 144-pin LQFP |  |

## PIN CONFIGURATIONS

80-pin plastic fine pitch BGA $(9 \times 9)$
$\star \quad \mu$ PD77115F1-CN6
$\mu$ PD77115AF1-xxx-CN6


| Pin No. | Pin Name | Pin No. | Pin Name | Pin No. | Pin Name | Pin No. | Pin Name |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A1 | EVdd | C3 | SDDAT | E6 | GND | G8 | $\overline{\text { HRE }}$ |
| A2 | NC | C4 | GND | E7 | $\overline{\text { HWR }}$ | G9 | EVdd |
| A3 | EVdd | C5 | INT3 | E8 | EVdd | H1 | GND |
| A4 | IVdD | C6 | TRST | E9 | CLKOUT | H2 | EVdd |
| A5 | INT2 | C7 | TICE | F1 | EVdd | H3 | HD12 |
| A6 | RESET | C8 | TDO | F2 | P0 | H4 | EVdd |
| A7 | TDI | C9 | HAO | F3 | P3 | H5 | GND |
| A8 | I.C. | D1 | SOEN/LRCLK | F4 | HD9 | H6 | HD2 |
| A9 | I.C. | D2 | P5/PLL1 | F5 | HD4 | H7 | IVdD |
| B1 | NC | D3 | SO | F6 | HRD | H8 | HDO |
| B2 | SI | D4 | P7/PLL3 | F7 | HWE | H9 | GND |
| B3 | SDCR | D5 | SDCLK | F8 | CLKIN | J1 | NC |
| B4 | GND | D6 | INT4 | F9 | HCS | J2 | GND |
| B5 | WAKEUP | D7 | IVDD | G1 | P1 | J3 | HD13 |
| B6 | $\overline{\text { INT1 }}$ | D8 | HA1 | G2 | HD15 | J4 | HD10 |
| B7 | TMS | D9 | GND | G3 | HD14 | J5 | HD7 |
| B8 | TCK | E1 | P6/PLL2 | G4 | HD11 | J6 | HD6 |
| B9 | I.C. | E2 | P4/PLL0 | G5 | HD8 | J7 | HD3 |
| C1 | SIEN/MCLK | E3 | GND | G6 | HD5 | J8 | GND |
| C2 | SCK/BCLK | E4 | P2 | G7 | HD1 | J9 | I.C. |

## 80-pin plastic TQFP (fine pitch) ( $12 \times 12$ ) (Top view)

 $\mu$ PD77115GK-9EU

| Pin No. | Pin Name | Pin No. | Pin Name | Pin No. | Pin Name | Pin No. | Pin Name |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | SI | 21 | EVDD | 41 | HD0 | 61 | TCK |
| 2 | NC | 22 | GND | 42 | GND | 62 | I.C. |
| 3 | SIEN/MCLK | 23 | HD13 | 43 | EVDD | 63 | TDI |
| 4 | SCK/BCLK | 24 | HD12 | 44 | $\overline{\text { HRE }}$ | 64 | TMS |
| 5 | SO | 25 | HD11 | 45 | $\overline{\text { HWE }}$ | 65 | $\overline{\text { TRST }}$ |
| 6 | SOEN/LRCLK | 26 | HD10 | 46 | $\overline{\text { HCS }}$ | 66 | $\overline{\text { RESET }}$ |
| 7 | P7/PLL3 | 27 | HD9 | 47 | $\overline{\text { HRD }}$ | 67 | $\overline{\text { INT4 }}$ |
| 8 | GND | 28 | HD8 | 48 | $\overline{\text { HWR }}$ | 68 | $\overline{\text { INT3 }}$ |
| 9 | P6/PLL2 | 29 | HD7 | 49 | CLKOUT | 69 | $\overline{\text { INT2 }}$ |
| 10 | P5/PLL1 | 30 | EVDD | 50 | CLKIN | 70 | $\overline{\text { INT1 }}$ |
| 11 | P4/PLLO | 31 | GND | 51 | EVDD | 71 | $\overline{\text { WAKEUP }}$ |
| 12 | EVDD | 32 | HD6 | 52 | GND | 72 | IVDD |
| 13 | P3 | 33 | HD5 | 53 | IVDD | 73 | GND |
| 14 | P2 | 34 | HD4 | 54 | GND | 74 | SDCLK |
| 15 | P1 | 35 | HD3 | 55 | HA0 | 75 | EVDD |
| 16 | P0 | 36 | HD2 | 56 | HA1 | 76 | GND |
| 17 | HD15 | 37 | IVDD | 57 | TDO | 77 | SDCR |
| 18 | GND | 38 | GND | 58 | I.C. | 78 | NC |
| 19 | NC | 39 | I.C. | 59 | I.C. | 79 | SDDAT |
| 20 | HD14 | 40 | HD1 | 60 | TICE | 80 | EVDD |

## PIN NAME

| CLKIN | Clock Input |
| :---: | :---: |
| CLKOUT | : Clock Output |
| EVDD | Power Supply for I/O Pins |
| GND | Ground |
| HAO, HA1 | Host Data Access |
| HCS | : Host Chip Select |
| HD0 to HD15 | Host Data Bus |
| $\overline{\text { HRD }}$ | Host Read |
| HRE | : Host Read Enable |
| HWE | Host Write Enable |
| $\overline{H W R}$ | Host Write |
| I.C. | : Internally Connected |
| $\overline{\text { INT1 }}$ to $\overline{\text { INT4 }}$ | : Interrupt |
| IVDD | : Power Supply for DSP Core |
| NC | : Non-Connection |
| P0 to P3 | Port |
| P4/PLL0 to P7/PLL3 : Port/ PLL Setting Input |  |
| RESET | Reset |
| SCK/BCLK | : Serial Clock Input/ Output |
| SDCLK | SD Card Clock Output |
| SDCR | SD Card Command Output/ Response Input |
| SDDAT | : SD Card Data Input/ Output |
| SI | Serial Data Input |
| SIEN/MCLK | Serial Input Enable/ Master Clock Input |
| SO | Serial Data Output |
| SOEN/LRCLK | Serial Output Enable/ Left Right Clock Input/ Output |
| TCK | Test Clock Input |
| TDI | Test Data Input |
| TDO | Test Data Output |
| TICE | Test In-Circuit Emulator |
| TMS | Test Mode Select |
| TRST | : Test Reset |
| WAKEUP | : Wakeup from STOP Mode |

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## 1. PIN FUNCTION

Because the pin numbers differ depending on the package, refer to the diagram of the package to be used.

### 1.1 Pin Function Description

## - Power supply

| Pin Name | Pin No. |  | I/O | Function | Shared by: |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | 80-pin FBGA | 80-pin TQFP |  |  |  |
| IVdo | A4,D7,H7 | 37,53,72 | - | Power to DSP core (+2.5 V) | - |
| EVDD | $\begin{aligned} & \text { A1,A3,E8,F1, } \\ & \text { G9,H2,H4 } \end{aligned}$ | $\begin{aligned} & 12,21,30,43,51, \\ & 75,80 \end{aligned}$ | - | Power to I/O pins (+3 V) | - |
| GND | B4,C4,D9,E3, E6,H1,H5,H9, J2,J8 | $\begin{array}{\|l} \hline 8,18,22,31, \\ 38,42,52,54, \\ 73,76 \\ \hline \end{array}$ | - | Ground | - |

## - System control

| Pin Name | Pin No. |  | I/O | Function | Shared by: |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | 80-pin FBGA | 80-pin TQFP |  |  |  |
| CLKIN | F8 | 50 | Input | System clock input | - |
| CLKOUT | E9 | 49 | Output | Internal system clock output | - |
| PLLO to PLL3 | E2,D2,E1,D4 | 11,10,9,7 | Input | PLL multiple rate setting pin <br> PLL3 to PLLO: $\begin{array}{ll} 0000: x 16, & 0001: x, \quad 0010: x 2, \\ 0100: x 4, & 0101: x 5, \\ 0110: x 6, & 0111: x 3 \\ 1000: x 8, & 1001: x, \\ 1100: x 12, & 11010: x 10, \\ 1111: x 15 \end{array}$ | P4 to P7 |
| $\overline{\text { RESET }}$ | A6 | 66 | Input | Internal system reset signal input | - |
| WAKEUP | B5 | 71 | Input | Stop mode release signal input. <br> - When this pin is asserted active, the stop mode is released. | - |

## - Interrupt

| Pin Name | Pin No. |  | I/O | Function | Shared by: |
| :---: | :---: | :---: | :---: | :--- | :---: |
|  | 80-pin FBGA | 80-pin TQFP |  |  | - |
| $\overline{\text { INT1 to INT4 }}$ | B6,A5,C5,D6 | $70,69,68,67$ | Input | External maskable interrupt input. <br> • |  |

## - Serial interface

| Pin Name | Pin No. |  | I/O | Function | Shared by: |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | 80-pin FBGA | 80-pin TQFP |  |  |  |
| SCK/BCLK | C2 | 4 | I/O | Serial clock input/output SCK : Standard serial interface(input) BCLK : Audio serial interface(//O) | - |
| SOEN/LRCLK | D1 | 6 | I/O | Serial output enable / Left Right clock input/output <br> SOEN : Standard serial interface(input) <br> LRCLK : Audio serial interface(I/O) | - |
| SO | D3 | 5 | Output (3S) | Serial data output | - |
| SIEN/MCLK | C1 | 3 | Input | Serial input enable / Master clock input <br> SIEN : Standard serial interface <br> MCLK : Audio serial interface (Master clock input when master mode) | - |
| SI | B2 | 1 | Input | Serial data input | - |

Remark The pins marked " 3 S " under the heading " $\mathrm{I} / \mathrm{O}$ " go into a high-impedance state on completion of data transfer and input of the hardware reset ( $\overline{\mathrm{RESET}}$ ) signal.

## - SD card interface

| Pin Name | Pin No. |  | I/O | Function | Shared by: |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | 80-pin FBGA | 80-pin TQFP |  |  |  |
| SDCLK | D5 | 74 | Output | SD card clock output | - |
| SDCR | B3 | 77 | I/O (3S) | SD card command/response Input : Response <br> Output : Command <br> -Leave pulled up. | - |
| SDDAT | C3 | 79 | $\begin{aligned} & \text { I/O } \\ & \text { (3S) } \end{aligned}$ | SD card data input/output <br> Input : Read data <br> Output: Write data <br> -Leave pulled up. | - |

Remark The pins marked " 3 "" under the heading "I/O" go into a high-impedance state when the SD card interface is not being accessed.

- Host interface

| Pin Name | Pin No. |  | I/O | Function | Shared by: |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | 80-pin FBGA | 80-pin TQFP |  |  |  |
| HA1 | D8 | 56 | Input | Specifies the register to be accessed by HD15 to HDO. <br> - 1: Accesses the host interface status register (HST). <br> - 0: Accesses the host transmit data register (HDT (out)) when read ( $\overline{\mathrm{HRD}}=0$ ), and host receive data register (HDT (in)) when written ( $\mathrm{HWR}=0$ ). | - |
| HAO | C9 | 55 | Input | Specifies the register to be accessed by HD15 to HDO. <br> - 1: Accesses bits 15 to 8 of HST, HDT (in), and HDT (out). <br> - 0 : Accesses bits 7 to 0 of HST, HDT (in), and HDT (out). <br> When 8-bit mode, this signal becomes valid. When 16-bit mode, this signal becomes invalid. | - |
| $\overline{\mathrm{HCS}}$ | F9 | 46 | Input | Chip select input | - |
| $\overline{\mathrm{HRD}}$ | F6 | 47 | Input | Host read input | - |
| $\overline{\mathrm{HWR}}$ | E7 | 48 | Input | Host write input | - |
| $\overline{\text { HRE }}$ | G8 | 44 | Output | Host read enable output | - |
| $\overline{\text { HWE }}$ | F7 | 45 | Output | Host write enable output | - |
| HD0 to HD15 | H8,G7,H6,J7, <br> F5,G6,J6,J5, <br> G5,F4,J4,G4, <br> H3,J3,G3,G2 | $\begin{aligned} & 41,40,36,35, \\ & 34,33,32,29, \\ & 28,27,26,25, \\ & 24,23,20,17 \end{aligned}$ | I/O <br> (3S) | 16-bit host data bus | - |

Remark The pins marked " 3 S" under the heading "I/O" go into a high-impedance state when the host interface is not being accessed.

## - I/O ports

| Pin Name | Pin No. |  | I/O | Function | Shared by: |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | 80-pin FBGA | 80-pin TQFP |  |  |  |
| P0 | F2 | 16 | I/O | General-purpose I/O port | - |
| P1 | G1 | 15 | I/O |  | - |
| P2 | E4 | 14 | I/O |  | - |
| P3 | F3 | 13 | I/O |  | - |
| P4 | E2 | 11 | 1/O |  | PLLO |
| P5 | D2 | 10 | 1/O |  | PLL1 |
| P6 | E1 | 9 | 1/O |  | PLL2 |
| P7 | D4 | 7 | I/O |  | PLL3 |

- Debugging interface

| Pin Name | Pin No. |  | I/O | Function | Shared by: |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | 80-pin FBGA | 80-pin TQFP |  |  |  |
| TDO | C8 | 57 | Output | For debugging | - |
| TICE | C7 | 60 | Output |  | - |
| TCK | B8 | 61 | Input |  | - |
| TDI | A7 | 63 | Input |  | - |
| TMS | B7 | 64 | Input |  | - |
| TRST | C6 | 65 | Input |  | - |

- Others

| Pin Name | Pin No. |  | I/O |  | Function |
| :--- | :--- | :--- | :--- | :--- | :---: |
|  | 80-pin FBGA |  |  |  | - |
| I.C. | A8,A9,B9,J9 | $39,58,59,62$ | - | Internally connected. Leave this pin <br> unconnected. | - |
| NC | A2,B1,J1 | $2,19,78$ | - | No-connect pins. Leave these pins <br> unconnected. | - |

Caution If any signal is input to these pins or if an attempt is made to read these pins, the normal operation of the $\mu \mathrm{PD} 77115$ is not guaranteed.

### 1.2 Connection of Unused Pins

### 1.2.1 Connection of function pins

When mounting, connect unused pins as follows:

| Pin | I/O | Recommended Connection |
| :---: | :---: | :---: |
| $\overline{\mathrm{INT} 1}$ to $\overline{\mathrm{NT} 4}$ | Input | Connect to $\mathrm{EV} \mathrm{VD}^{\text {. }}$ |
| SCK/BCLK | I/O | Connect to EVdD or GND. |
| SI | Input |  |
| SIEN/MCLK | Input | Connect to GND. |
| SOEN/LRCLK | I/O |  |
| SO | Output | Leave unconnected |
| SDCLK | Output |  |
| SDCR | I/O | Connect to EVDD via pull-up resistor, or connect to GND via pull-down resistor. |
| SDDAT | I/O |  |
| HAO, HA1 | Input | Connect to EVDD or GND. |
| $\overline{\mathrm{HCS}}, \overline{\mathrm{HRD}}, \overline{\mathrm{HWR}}$ | Input | Connect to EVDD. |
| $\overline{\text { HRE, }} \overline{\text { HWE }}$ | Output | Leave unconnected. |
| HDO to HD15 ${ }^{\text {Note }}$ | I/O | Connect to EVDD via pull-up resistor, or connect to GND via pull-down resistor. |
| P0 to P3 | I/O |  |
| TCK | Input | Connect to GND via pull-down resistor. |
| TDO, TICE | Output | Leave unconnected. |
| TMS, TDI | Input | Leave unconnected. (internally pulled up). |
| TRST | Input | Leave unconnected. (internally pulled down). |
| CLKOUT | Output | Leave unconnected. |
| $\overline{\text { WAKEUP }}$ | Input | Connect to EVDD. |

Note These pins may be left unconnected if $\overline{\mathrm{HCS}}, \overline{\mathrm{HRD}}$, and $\overline{\mathrm{HWR}}$ are fixed to the high level.
However, connect these pins as recommended in the halt and stop modes when the power consumption must be lowered.

### 1.2.2 Connection of no-function pins

| Pin | I/O | Recommended Connection |
| :--- | :---: | :--- |
| I.C. | - | Leave unconnected. |
| NC | - | Leave unconnected. |

## 2. FUNCTION OUTLINE

### 2.1 Program Control Unit

This unit is used to execute instructions, and control branching, loops, interrupts, the clock, and the standby mode of the DSP.

### 2.1.1 CPU control

A three-stage pipeline architecture is employed and almost all the instructions, except some instructions such as branch instructions, are executed in one system clock.

### 2.1.2 Interrupt control

Interrupt requests input from external pins ( $\overline{\mathrm{NT} 1}$ to $\overline{\mathrm{NT} 4}$ ) or generated by the internal peripherals (serial interface and host interface) are serviced. The interrupt of each interrupt source can be enabled or disabled. Multiple interrupts are also supported.

### 2.1.3 Loop control task

A loop function without any hardware overhead is provided. A loop stack with four levels is provided to support multiple loops.

### 2.1.4 PC stack

A 15-level PC stack that stores the program counter supports multiple interrupts and subroutine calls.

### 2.1.5 PLL

A PLL is provided as a clock generator that can multiply an external clock input to supply an operating clock to the DSP. A multiple of $\times 1$ to $\times 16$ can be set by pins(PLL0 to PLL3).

Two standby modes are available for lowering the power consumption while the DSP is not in use.

- HALT mode: Set by execution of the HALT instruction. The current consumption drops to several mA. The normal operation mode is recovered by an interrupt or hardware reset.
- STOP mode: Set by execution of the STOP instruction. The current consumption drops to several $10 \mu \mathrm{~A}$. The normal operation mode is recovered by hardware reset or $\overline{\text { WAKEUP }}$ pin.


### 2.1.6 Instruction memory

64 words of the instruction RAM are allocated to interrupt vectors.
A boot-up ROM that boots up the instruction RAM is provided, and the instruction RAM can be initialized or rewritten by host boot (boot via host interface).

The $\mu$ PD77115 has 11.5 K -word instruction RAM.

### 2.2 Arithmetic Unit

This unit performs multiplication, addition, logical operations, and shift, and consists of a 40-bit multiply accumulator, 40-bit data ALU, 40-bit barrel shifter, and eight 40-bit general-purpose registers.

### 2.2.1 General-purpose registers (R0 to R7)

These eight 40-bit registers are used to input/output data for arithmetic operations, and load or store data from/to data memory.

A general-purpose register (R0 to R7) is made up of three parts: R0L to R7L (bits 15 to 0), R0H to R7H (bits 31 to 16), and R0E to R7E (bits 39 to 32). Depending on the type of operation, RnL, RnH, and RnE are used as one register or in different combinations.

### 2.2.2 Multiply accumulator (MAC)

The MAC multiplies two 16-bit values, and adds or subtracts the multiplication result from one 40-bit value, and outputs a 40-bit value.

The MAC is provided with a shifter (MSFT: MAC ShiFTer) at the stage preceding the input stage. This shifter can arithmetically shift the 40-bit value to be added to or subtracted from the multiplication result 1 or 16 bits to the right .

### 2.2.3 Arithmetic logic unit (ALU)

This unit inputs one or two 40-bit values, executes an arithmetic or logical operation, and outputs a 40-bit value.

### 2.2.4 Barrel shifter (BSFT: Barrel ShiFTer)

The barrel shifter inputs a 40-bit value, shifts it to the left or right by any number of bits, and outputs a 40-bit value. The data may be arithmetically shifted to the right shifted to the right, in which case the data is sign-extended, or logically shifted to the right, in which case 0 is inserted from the MSB.

### 2.3 Data Memory Unit

The data memory unit consists of two banks of data memory and two data addressing units.

### 2.3.1 Data memory

The DSP have two banks of data memory ( X data memory and Y data memory). A 64-word peripheral area is assigned in the data memory space.

The $\mu$ PD77115 has 16 K words $\times 2$ banks data RAM.

### 2.3.2 Data addressing unit

An independent data addressing unit is provided for each of the X data memory and Y data memory spaces.
Each data addressing unit has four data pointers (DPn), four index registers (DNn), one modulo register (DMX or DMY), and an address ALU.

### 2.4 Peripheral Unit

A serial interface, host interface, general-purpose I/O port, and wait cycle register are provided. All these internal peripherals are mapped to the $X$ data memory and $Y$ data memory spaces, and are accessed from program as memory-mapped I/Os.

### 2.4.1 Audio Serial interface (ASIO)

One serial interface is provided. This serial interface has two mode which are the audio serial and the standard serial. The standard serial is compatible other $\mu$ PD77111 family DSP.

The audio serial interfaces have the following features:

- Mode : Master mode or Slave mode

Master mode : MCLK (input), BCLK (output), LRCLK (output), support 256 fs, 384 fs and 512 fs
Slave mode : MCLK (unused), BCLK (input), LRCLK (input)

- Frame format : 32 or 64 bits audio format (LRCLK format), MSB first input/output.
- Handshake : Handshaking with the external devices is implemented with a dedicated frame signal (LRCLK).

Handshaking with the internal units, polling, wait, or interrupt are used.

The standard serial interfaces have the following features:

- Serial clock : Supplied from external source to each interface. The same clock is used for input and output on the interface.
- Frame length : 8 or 16 bits, and MSB or LSB first selectable for each input or output
- Handshake : Handshaking with external devices is implemented with a dedicated status signal. With the internal units, polling, wait, or interrupt are used.


### 2.4.2 Host interface (HIO)

This is an 16-bit parallel port that inputs data from or outputs data to an external host CPU or DMA controller. In the DSP, a 16-bit register is mapped to memory for input data, output data, and status. Handshaking with an external device is implemented by using a dedicated status signal or a dedicated status register. Handshaking with internal units is achieved by means of polling, wait, or interrupts.

### 2.4.3 General-purpose I/O port (PIO)

This is a 8-bit I/O port that can be set in the input or output mode in 1-bit units.

### 2.4.4 SD card interface (SDCIF)

This interface is for access SD card. It supports the DMA transfer for input data to internal data RAM. The SD card is accessed by using a dedicated routine of system ROM.

### 2.4.5 Timer

This is 16-bit timer unit. The count source can be selected from system clock, SD card clock, serial clock and INT4 input. Timer unit generates interrupt for interface internal units.

## 3. RESET FUNCTION

When a low level of a specified width is input to the $\overline{\text { RESET }}$ pin, the device is initialized.

### 3.1 Hardware Reset

If the $\overline{\text { RESET }}$ pin is asserted active (low level) for a specified period, the internal circuitry of the DSP is initialized. If the RESET pin is then deasserted inactive (high level), boot processing of the instruction RAM is performed according to the status of the port pins ( P 0 and P 1 ). After boot processing, processing is executed starting from the instruction at address $0 \times 200$ of instruction memory (reset entry).

No power-ON reset function is available.

### 3.2 Initializing PLL

Initializing the PLL starts during boot up program at reset. The pins (PLLO to PLL3) that specify the PLL multiple rate must be kept stable for the duration of 3 clocks before and for the duration of 50 clocks after reset has been cleared (the clock is input from CLKIN). It takes the PLL $100 \mu$ s to be locked. Until the PLL is lacked, the DSP internal is operated by the CLKIN clock.

To use the PLL clock as an internal operating clock, set the clock control register (internal peripheral) by user program.

## 4. FUNCTIONS OF BOOT-UP ROM

To rewrite the contents of the instruction memory on power application or from program, boot up the instruction RAM by using the internal boot-up ROM.

The $\mu \mathrm{PD} 77115$ has a function to verify the contents of the internal instruction RAM.

### 4.1 Boot at Reset

After hardware reset has been cleared, the boot program first reads the general-purpose I/O ports P0 and P1 and, depending on their bit pattern, determines the boot mode (host boot or non boot). After boot processing, processing is executed starting from the instruction at address $0 \times 200$ (reset entry) of the instruction memory.

The pins ( P 0 and P 1 ) that specify the boot mode must be kept stable for the duration of 3 clocks before and for the duration of 12 clocks after reset has been cleared (the clock is input from CLKIN).

| P1 | P0 |  |
| :--- | :--- | :--- |
| 0 | 0 | Boot Mode |
| 0 | 1 | Executes host byte boot and then branches to address 0x200. |
| 1 | 0 | Setting prohibited |
| 1 | 1 | Executes host word boot and then branches to address $0 \times 200$. |

Note This setting is used when the DSP must be reset to recover from the standby mode after reset boot has been executed once.

A boot parameter and instruction code are obtained via the host interface, and transferred to the instruction RAM. The data transfer support byte mode and word mode.

### 4.2 Reboot

By calling the reboot entry address from the program, the contents of the instruction RAM can be rewritten. An instruction code is obtained via the host interface and transferred to the instruction RAM. The data transfer support byte mode and word mode.

The entry address is $0 x 6$. Host reboot is executed by calling this address after setting the following parameter:

- R7L: Number of instruction steps for rebooting
- DP3: First address of instruction memory to be loaded


### 4.3 Signature Operation

The $\mu$ PD77115 has a signature operation function so that the contents of the internal instruction RAM can be verified. The signature operation performs a specific arithmetic operation on the data in the instruction RAM booted up, and returns the result to a register. Perform the signature operation in advance on the device when it is operating normally, and repeat the signature operation later to check whether the data in RAM is correct by comparing the operation result with the previous result. If the results are identical, there is no problem.

The entry address is $0 \times 9$. Execute the operation by calling this address after setting the following parameter. The operation result is stored in register R7.

- R7L: Number of instruction steps for operation
- DP3: First address of instruction memory for operation


## 5. STANDBY MODES

Two standby modes are available. By executing the corresponding instruction, each mode is set and the power consumption can be reduced.

### 5.1 HALT Mode

To set this mode, execute the HALT instruction. In this mode, functions other than clock circuit and PLL are stopped to reduce the current consumption.

To release the HALT mode, use an interrupt or hardware reset. When releasing the HALT mode using an interrupt, the contents of the internal registers and memory are retained. It takes several 10 system clocks to release the HALT mode when the HALT mode is released using an interrupt.

In the HALT Mode, the clock circuit of the $\mu$ PD77115 supplies the following clock as the internal system clock. The clock output from the CLKOUT pin is also as follows.

The clock output from the CLKOUT pin, however, has a high-level width that is equivalent to 1 cycle of the normal operation (i.e., the duty factor is not $50 \%$ ).

- $\mu$ PD77115: $1 / I$ of internal system clock ( $I=$ integer from 1 to 16 , specified by register $)$


### 5.2 STOP Mode

To set the STOP mode, execute the STOP instruction. In the STOP mode, all the functions, including the clock circuit and PLL, can be stopped and the power consumption is minimized with only leakage current flowing.

To release the STOP mode, use hardware reset or WAKEUP pin.
When releasing the STOP mode by using the $\overline{\text { WAKEUP }}$ pin, the contents of the internal registers and memory are retained, but it takes several $100 \mu$ s to release the mode.

## 6. MEMORY MAP

A Harvard architecture, in which the instruction memory space and data memory space are separated is employed.

### 6.1 Instruction Memory

6.1.1 Instruction memory map

| 0xFFFFF | System |
| :---: | :---: |
| $0 \times A 000$ |  |
|  | Instruction RAM (8K words) |
| 0x8000 |  |
|  | System |
| $\begin{aligned} & 0 \times 1000 \\ & 0 x 0 F F F \end{aligned}$ |  |
| 0x0240 | Instruction RAM (3.5K words) |
| $\begin{aligned} & 0 \times 023 F \\ & 0 \times 0200 \end{aligned}$ | Vector area (64 words) |
| $0 \times 0000$ | Boot-up ROM (512 words) |

Caution Programs and data cannot be placed at addresses reserved for the system, nor can these addresses be accessed. If these addresses are accessed, the normal operation of the device cannot be guaranteed.

### 6.1.2 Interrupt vector table

Addresses $0 \times 200$ to $0 \times 23 F$ of the instruction memory are entry points (vectors) of interrupts. Four instruction addresses are assigned to each interrupt source.

| Vector | Interrupt Source |
| :--- | :--- |
| $0 \times 200$ | Reset |
| $0 \times 204$ |  |
| $0 \times 208$ |  |
| $0 \times 20 \mathrm{C}$ |  |
| $0 \times 210$ | INT2 |
| $0 \times 214$ | INT3 |
| $0 \times 218$ | INT4 |
| $0 \times 21$ C | SI input |
| $0 \times 220$ | SO output |
| $0 \times 224$ | SDDAT input $/$ PBU |
| $0 \times 228$ | SDDAT output |
| $0 \times 22 C$ | HI input |
| $0 \times 230$ | HO output |
| $0 \times 234$ | SDCR input |
| $0 \times 238$ | Timer |
| $0 \times 23 C$ |  |

Cautions 1. Although reset is not an interrupt, it is handled like an interrupt as an entry to a vector.
2. It is recommended that unused interrupt source vectors be used to branch an error processing routine.

### 6.2 Data Memory

### 6.2.1 Data memory map

| 0xFFFF |  |
| :---: | :---: |
|  | System |
| $\begin{aligned} & 0 \times 6000 \\ & 0 \times 5 F F F \end{aligned}$ |  |
|  | Data RAM (8K words) |
| $0 \times 4000$ |  |
| $0 \times 3 F F F$ | System |
| $\begin{aligned} & 0 \times 3840 \\ & 0 \times 383 F \\ & 0 \times 3800 \end{aligned}$ |  |
|  | Peripheral (64 words) |
| $\begin{aligned} & 0 \times 37 \mathrm{FF} \\ & 0 \times 3000 \end{aligned}$ | System |
| $\begin{aligned} & 0 \times 2 F F F \\ & 0 \times 2000 \end{aligned}$ | Data RAM (4K words) |
| 0x1FFF | System |
| $0 \times 1000$ | System |
| 0x0FFF | Data RAM (4K words) |

Caution Programs and data cannot be placed at addresses reserved for the system, nor can these addresses be accessed. If these addresses are accessed, the normal operation of the device cannot be guaranteed.

### 6.2.2 Internal peripherals

The internal peripherals are mapped to the internal data memory space.

| X/Y Memory Address | Register Name | Function | Peripheral Name |
| :---: | :---: | :---: | :---: |
| $0 \times 3800$ | SDT/ASDT | Serial data register | ASIO |
| $0 \times 3801$ | SST | Serial status register |  |
| 0x3802 | ASST | Audio serial status register |  |
| $0 \times 3803$ | Reserved area | Caution Do not access this area. | - |
| 0x3804 | PDT | Port data register | PIO |
| 0x3805 | PCD | Port command register |  |
| $0 \times 3806$ | HDT | Host data register | HIO |
| $0 \times 3807$ | HST | Host status register |  |
| $0 \times 3808$ to 0x380F | Reserved area | Caution Do not access this area. | - |
| $0 \times 3810$ | SDDR | SD card data register | SDCIF |
| $0 \times 3811$ | SDCMD_IDX | SD card command register index |  |
| $0 \times 3812$ | SDCMD_AGH | SD card command register argument high |  |
| $0 \times 3813$ | SDCMD_AGL | SD card command register argument low |  |
| $0 \times 3814$ | SDCTL | SD card control register |  |
| $0 \times 3815$ | SDRPR | SD card response register |  |
| $0 \times 3816$ | SDSBR | SD card CRC status busy register |  |
| $0 \times 3817$ to 0x381F | Reserved area | Caution Do not access this area. | - |
| 0x3820 | TIR | Timer initialize value register | Timer |
| $0 \times 3821$ | TCR | Timer count register |  |
| 0x3822 | TCSR | Timer control / status register |  |
| $0 \times 3823$ | TENR | Timer count enable register |  |
| $0 \times 3824$ to 0x382D | Reserved area | Caution Do not access this area. | - |
| 0x382E | CLKCNTL | Clock control register | PLL |
| 0x382F | Reserved area | Caution Do not access this area. | - |
| 0x3830 | PSAR | DMA start address register | SDCIF |
| 0x3831 | PSR | DMA size register |  |
| 0x3832 | PRR | DMA pointer register |  |
| 0x3833 | PCR | DMA control register |  |
| $0 \times 3834$ to 0x383F | Reserved area | Caution Do not access this area. | - |

Cautions 1. The register names listed in this table are not reserved words of the assembler or the $\mathbf{C}$ language. Therefore, when using these names in assembler or $\mathbf{C}$, the user must define them.
2. The same register is accessed, as long as the address is the same, regardless of whether the $X$ memory space or $Y$ memory space is accessed.
3. Even different registers cannot be accessed at the same time from both the $X$ and $Y$ memory spaces.

## 7. INSTRUCTIONS

### 7.1 Outline of Instructions

An instruction consists of 32 bits. Almost all the instructions, except some such as branch instructions, are executed with one system clock. The maximum instruction cycle of the $\mu$ PD77115 is 13.3 ns . The following nine types of instructions are available:

## (1) Trinomial operation instructions

These instructions specify an operation by the MAC. As the operands, three general-purpose registers can be specified.

## (2) Binomial operation instructions

These instructions specify an operation by the MAC, ALU, or BSFT. As the operands, two general-purpose registers can be specified. An immediate value can be specified for some of these instructions, instead of a general-purpose register, for one input.

## (3) Uninominal operation instructions

These instructions specify an operation by the ALU. As the operands, one general-purpose register can be specified.

## (4) Load/store instructions

These instructions transfer 16-bit values between memory and a general-purpose register. Any general-purpose register can be specified as the transfer source or destination.
(5) Register-to-register transfer instructions

These instructions transfer data from one general-purpose register to another.
(6) Immediate value setting instructions

These instructions write an immediate value to a general-purpose register and the registers of the address operation unit.
(7) Branch instructions

These instruction specify branching of program execution.
(8) Hardware loop instructions

These instruction specify repetitive execution of an instruction.
(9) Control instructions

These instructions are used to control the program.

### 7.2 Instruction Set and Operation

An operation is written in the operation field for each instruction in accordance with the operation representation format of that instruction. If two or more parameters can be written, select one of them.

## (a) Representation formats and selectable registers

The following table shows the representation formats and selectable registers.

| Representation Format |  |
| :--- | :--- |
| r0, r0', r0" | Relectable Register |
| rl, rl' | R0L to R7L |
| rh, rh' | R0H to R7H |
| re | R0E to R7E |
| reh | R0EH to R7EH |
| dp | DP0 to DP7 |
| dn | DN0 to DN7 |
| dm | DMX, DMY |
| dpx | DP4 to DP7 |
| dpy | DPn, DPn++, DPn- -, DPn\#\#, DPn\%\%, !DPn\#\# (n = 0 to 3) |
| dpx_mod | DPn, DPn++, DPn- -, DPn\#\#, DPn\%\%, !DPn\#\# (n = 4 to 7) |
| dpy_mod | DPn\#\#imm (n = 0 to 7) |
| dp_imm | Contents of memory with address xxx <br> <Example> If the contents of the DP0 register are 1000, *DP0 indicates the contents of <br> address 1000 of the memory. <br> *xxx |

(b) Modifying data pointer

The data pointer is modified after the memory has been accessed. The result of modification becomes valid starting from the instruction that immediately follows. The data pointer cannot be modified.

| Example | Operation |
| :---: | :---: |
| DPn | Nothing is done (value of DPn is not changed.) |
| DPn++ | $\mathrm{DPn} \leftarrow \mathrm{DPn}+1$ |
| DPn-- | $\mathrm{DPn} \leftarrow \mathrm{DPn}-1$ |
| DPn\#\# | $\mathrm{DPn} \leftarrow \mathrm{DPn}+\mathrm{DNn}$ <br> (Adds value of corresponding DN0 to DN7 to DP0 to DP7.) <br> Example: DPO $\leftarrow$ DPO + DNO |
| DPn\%\% | $(\mathrm{n}=0$ to 3) $\mathrm{DPn}=((\mathrm{DPL}+\mathrm{DNn}) \bmod (\mathrm{DMX}+1))+\mathrm{DP}$ н |
|  | $(\mathrm{n}=4$ to 7$) \mathrm{DPn}=((\mathrm{DPL}+\mathrm{DNn}) \bmod (\mathrm{DMY}+1))+\mathrm{DP}$ н |
| !DPn\#\# | Reverses bits of DPn and then accesses memory. After memory access, $\mathrm{DPn} \leftarrow \mathrm{DPn}+\mathrm{DNn}$ |
| DPn\#\#imm | $\mathrm{DPn} \leftarrow \mathrm{DPn}+\mathrm{imm}$ |

(c) Instructions that can be simultaneously written

Instructions that can be simultaneously written are indicated by O .
(d) Status of overflow flag (OV)

The status of the overflow flag is indicated by the following symbol:

- : Not affected
! : Set to 1 when overflow occurs

Caution If an overflow does not occur as a result of an operation, the overflow flag is not reset but retains the status before the operation.

Instruction Set

| Instruction | Instruction Name | Mnemonic | Operation | Instructions Simultaneously Written |  |  |  |  |  |  |  |  | Flag <br> OV |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Trino- <br> mial | Bino- <br> mial | Unino- <br> minal | $\begin{array}{\|l\|l} \text { Load/ } \\ \text { store } \end{array}$ | Transfer | Imme- <br> diate <br> value | $\begin{aligned} & \text { Bran- } \\ & \text { ch } \end{aligned}$ | Loop | Cont- <br> rol |  |
| Trinomial operation | Multiply add | $\mathrm{ro}=\mathrm{ro}+\mathrm{rh}$ * rh' | $\mathrm{ro} \leftarrow \mathrm{ro}+\mathrm{rh}$ * rh' |  |  |  | $\checkmark$ |  |  |  |  |  | $\dagger$ |
|  | Multiply sub | $\mathrm{ro}=\mathrm{ro}-\mathrm{rh}$ * rh' | $\mathrm{ro} \leftarrow \mathrm{ro}-\mathrm{rh}$ * rh' |  |  |  | $\checkmark$ |  |  |  |  |  | $\dagger$ |
|  | Sign unsign multiply add | $\mathrm{ro}=\mathrm{ro}+\mathrm{rh} * \mathrm{rl}$ <br> ( rl is in positive integer format.) | $\mathrm{ro} \leftarrow \mathrm{ro}+\mathrm{rh} * \mathrm{rl}$ |  |  |  | $\checkmark$ |  |  |  |  |  | $\dagger$ |
|  | Unsign unsign multiply add | $\mathrm{ro}=\mathrm{ro}+\mathrm{rl} \text { * } \mathrm{rl} \text { ' }$ <br> (rl and rl' are in positive integer format.) | $\mathrm{rO} \leftarrow \mathrm{ro}+\mathrm{rl}^{*} \mathrm{rl}{ }^{\prime}$ |  |  |  | $\checkmark$ |  |  |  |  |  | $\dagger$ |
|  | 1-bit shift multiply add | $r \mathrm{ra}=(\mathrm{ro>>} 1)+\mathrm{rh} * \mathrm{rh}^{\prime}$ | $\mathrm{ro} \leftarrow \frac{\mathrm{ro}}{2}+\mathrm{rh}$ * rh' |  |  |  | $\checkmark$ |  |  |  |  |  | $\dagger$ |
|  | 16-bit shift multiply add | $r 0=(r o \gg 16)+r{ }^{*}$ rh' | $\mathrm{ro} \leftarrow \frac{\mathrm{rO}}{2^{16}}+\mathrm{rh}{ }^{*}$ rh' |  |  |  | $\checkmark$ |  |  |  |  |  | - |
| Binomial operation | Multiply | $\mathrm{ro}=\mathrm{rh}^{*} \mathrm{rh}$ ' | ro $\leftarrow$ rh * rh' |  |  |  | $\checkmark$ |  |  |  |  |  | - |
|  | Add | ro" $=$ ro + ro' | $\mathrm{ro} \mathrm{\prime}$ ' $\leftarrow \mathrm{ro}+\mathrm{ro}{ }^{\prime}$ |  |  |  | $\checkmark$ |  |  |  |  |  | $\dagger$ |
|  | Immediate add | ro' $=$ ro +imm | $\begin{aligned} & \mathrm{ro} ’ \leftarrow \mathrm{ro}+\mathrm{imm} \\ & (\text { where imm } \neq 1) \end{aligned}$ |  |  |  |  |  |  |  |  |  | $\dagger$ |
|  | Sub | ro" $=$ ro - ro' | $\mathrm{ro} \mathrm{\prime}$ ' $\leftarrow \mathrm{ro}-\mathrm{ro}{ }^{\prime}$ |  |  |  | $\checkmark$ |  |  |  |  |  | $\dagger$ |
|  | Immediate sub | ro' $=$ ro -imm | $\begin{aligned} & \text { ro' } \leftarrow \mathrm{ro}-\mathrm{imm} \\ & (\text { where imm } \neq 1) \end{aligned}$ |  |  |  |  |  |  |  |  |  | $\dagger$ |
|  | Arithmetic right shift | ro' = ro SRA rl | $\mathrm{rO}^{\prime} \leftarrow \mathrm{ro} \gg \mathrm{rl}$ |  |  |  | $\checkmark$ |  |  |  |  |  | - |
|  | Immediate arithmetic right shift | ro' = ro SRA imm | ro' $\leftarrow$ ro >> imm |  |  |  |  |  |  |  |  |  | - |
|  | Logical right shift | ro' = ro SRL rl | $\mathrm{ro}^{\prime} \leftarrow \mathrm{ro} \gg \mathrm{rl}$ |  |  |  | $\checkmark$ |  |  |  |  |  | - |
|  | Immediate logical right shift | ro' = ro SRL imm | ro' $\leftarrow$ ro >> imm |  |  |  |  |  |  |  |  |  | $\bullet$ |
|  | Logical left shift | ro' = ro SLL rl | $\mathrm{ro}^{\prime} \leftarrow \mathrm{ro} \ll \mathrm{rl}$ |  |  |  | $\checkmark$ |  |  |  |  |  | $\bullet$ |
|  | Immediate logical left shift | ro' = ro SLL imm | ro' $\leftarrow$ ro $\ll$ imm |  |  |  |  |  |  |  |  |  | - |
|  | AND | ro" = ro \& ro' | $\mathrm{ro} \mathrm{\prime}$ ¢ ro \& ro' |  |  |  | $\checkmark$ |  |  |  |  |  | $\bullet$ |
|  | Immediate AND | ro' = ro \& imm | ro' $\leftarrow \mathrm{ro} \& \mathrm{imm}$ |  |  |  |  |  |  |  |  |  | - |
|  | OR | ro" = ro \\| ro' | ro" $\leftarrow$ ro \| ro' |  |  |  | $\checkmark$ |  |  |  |  |  | - |
|  | Immediate OR | ro' = ro $\\| \mathrm{imm}$ | ro' $\leftarrow$ ro \\| imm |  |  |  |  |  |  |  |  |  | - |
|  | Exclusive OR | ro" = ro ^ ro' | $\mathrm{ro} \mathrm{\prime}$ ¢ $\mathrm{rO}^{\wedge}$ ro' |  |  |  | $\checkmark$ |  |  |  |  |  | $\bullet$ |
|  | Immediate exclusive OR | ro' $=$ ro ^imm | ro' $\leftarrow$ ro ^ imm |  |  |  |  |  |  |  |  |  | - |


| Instruction | Instruction Name | Mnemonic | Operation | Instructions Simultaneously Written |  |  |  |  |  |  |  |  | Flag <br> OV |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | $\begin{aligned} & \text { Trino- } \\ & \text { mial } \end{aligned}$ | Bino- <br> mial | Unino- <br> minal | $\begin{aligned} & \text { Load/ } \\ & \text { store } \end{aligned}$ | $\begin{aligned} & \text { Trans- } \\ & \text { fer } \end{aligned}$ | Imme- <br> diate <br> value | $\begin{aligned} & \text { Bran- } \\ & \text { ch } \end{aligned}$ | Loop | $\begin{aligned} & \text { Cont- } \\ & \text { rol } \end{aligned}$ |  |
| Binomial operation | Less than | ro" = LT (ro, ro') | $\begin{aligned} & \text { if }(\mathrm{ro}<\mathrm{ro}) \\ & \left\{\mathrm{rrO}^{\prime \prime} \leftarrow 0 \times 0000000001\right\} \\ & \text { else }\left\{\mathrm{ro}^{\prime \prime} \leftarrow 0 \times 0000000000\right\} \end{aligned}$ |  |  |  | $\sqrt{ }$ |  |  |  |  |  | - |
| Uninominal operation | Clear | CLR (ro) | $\mathrm{ro} \leftarrow 0 \times 0000000000$ |  |  |  | $\checkmark$ |  |  |  |  | $\checkmark$ | - |
|  | Increment | ro' = ro + 1 | $\mathrm{ro}^{\prime} \leftarrow \mathrm{ro}+1$ |  |  |  | $\sqrt{ }$ |  |  |  |  | $\checkmark$ | $\dagger$ |
|  | Decrement | ro' = ro - 1 | ro' $\leftarrow$ ro - 1 |  |  |  | $\checkmark$ |  |  |  |  | $\checkmark$ | $\dagger$ |
|  | Absolute value | ro' $=\mathrm{ABS}$ (ro) | $\begin{aligned} & \text { if }(\text { ro }<0) \\ & \{\text { ro' } \leftarrow-\text { ro }\} \\ & \text { else }\left\{\mathrm{ro}^{\prime} \leftarrow \mathrm{ro}\right\} \end{aligned}$ |  |  |  | $\sqrt{ }$ |  |  |  |  | $\checkmark$ | ; |
|  | 1's complement | ro' $=\sim$ ro | ro' $\leftarrow \sim$ ro |  |  |  | $\checkmark$ |  |  |  |  | $\checkmark$ | - |
|  | 2's complement | ro' $=-\mathrm{ro}$ | ro' $\leftarrow-\mathrm{ro}$ |  |  |  | $\checkmark$ |  |  |  |  | $\checkmark$ | ! |
|  | Clip | ro' = CLIP (ro) | $\begin{aligned} & \text { if }(\text { ro }>0 \times 007 F F F F F F F) \\ & \left\{\mathrm{ro}^{\prime} \leftarrow 0 \times 007 F F F F F F F\right\} \\ & \text { elseif }\{r 0<0 x F F 80000000\} \\ & \left\{\mathrm{ro}^{\prime} \leftarrow 0 \times F F 80000000\right\} \\ & \text { else }\left\{\mathrm{ro}^{\prime} \leftarrow \mathrm{ro} \mathrm{\}}\right. \end{aligned}$ |  |  |  | $\checkmark$ |  |  |  |  | $\checkmark$ | - |
|  | Round | ro' = ROUND (ro) | $\begin{aligned} & \text { if }(\text { ro > Ox007FFF0000 }) \\ & \left\{r 0^{\prime} \leftarrow 0 \times 007 F F F 0000\right\} \\ & \text { elseif }\{r 0<0 x F F 80000000\} \\ & \left\{r^{\prime} \leftarrow 0 x F F 80000000\right\} \\ & \text { else }\left\{r 0^{\prime} \leftarrow(\mathrm{ro}+0 \times 8000)\right. \\ & \& 0 x F F F F F 0000\} \end{aligned}$ |  |  |  | $\sqrt{ }$ |  |  |  |  | $\checkmark$ | - |
|  | Exponent | ro' = EXP (ro) | ro' $\leftarrow \log _{2}\left(\frac{1}{\mathrm{rO}}\right)$ |  |  |  | $\sqrt{ }$ |  |  |  |  | $\checkmark$ | - |
|  | Substitution | ro' = ro | ro' $\leftarrow$ ro |  |  |  | $\checkmark$ |  |  |  |  | $\checkmark$ | - |
|  | Accumulated addition | ro' $+=$ ro | $\mathrm{ro}^{\prime} \leftarrow \mathrm{ro}^{\prime}+\mathrm{ro}$ |  |  |  | $\checkmark$ |  |  |  |  | $\checkmark$ | $\dagger$ |
|  | Accumulated subtraction | ro' $-=\mathrm{ro}$ | $\mathrm{ro}^{\prime} \leftarrow$ ro' - ro |  |  |  | $\checkmark$ |  |  |  |  | $\checkmark$ | $\dagger$ |
|  | Division | ro' / = ro | $\begin{aligned} & \text { if }\left(\text { sign }\left(\mathrm{ro}^{\prime}\right)==\operatorname{sign}(\mathrm{ro})\right) \\ & \left\{\mathrm{ro}^{\prime} \leftarrow\left(\mathrm{ro}^{\prime}-\mathrm{ro}\right) \ll 1\right\} \\ & \text { else } \\ & \left\{\mathrm{ro}^{\prime} \leftarrow\left(\mathrm{ro}^{\prime}+\mathrm{ro}\right) \ll 1\right\} \\ & \text { if }\left(\operatorname{sign}\left(\mathrm{ro}^{\prime}\right)==0\right) \\ & \left\{\mathrm{ro}^{\prime} \leftarrow \mathrm{ro}^{\prime}+1\right\} \end{aligned}$ |  |  |  | $\checkmark$ |  |  |  |  | $\checkmark$ | $\dagger$ |



Notes 1. Of the two mnemonics, either one of them or both can be written.
2. After transfer, modification specified by mod is performed.
3. Select any of dest, dest' $=\{r o, r e h, r e, r h, r l\}$, source, source' $=\{r e, r h, r l\}$.
4. Select any of dest $=\left\{r o\right.$, reh, re, rh, rl\}, source $=\{r e, r h, r l\}$, addr $=\left\{\begin{array}{l}0: X-0 x F F F: X(X \text { memory }) \\ 0: Y-0 x F F F F: ~ Y(Y \text { memory })\end{array}\right\}$.
5. Select any of dest $=\{r o, r e h, r e, r h, r l\}$, source $=\{r e, r h, r l\}$.
6. Select any register other than general-purpose registers as dest and source.

| Instruction | Instruction Name | Mnemonic | Operation | Instructions Simultaneously Written |  |  |  |  |  |  |  |  | Flag <br> OV |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Trino- mial | $\begin{aligned} & \text { Bino- } \\ & \text { mial } \end{aligned}$ | Uninominal | $\begin{aligned} & \text { Load/ } \\ & \text { store } \end{aligned}$ | Transfer | $\left\lvert\, \begin{aligned} & \text { Imme- } \\ & \text { diate } \\ & \text { value } \end{aligned}\right.$ | $\begin{aligned} & \text { Bran- } \\ & \text { ch } \end{aligned}$ | Loop | $\begin{aligned} & \text { Cont- } \\ & \text { rol } \end{aligned}$ |  |
| Branch | Jump | JMP imm | $\mathrm{PC} \leftarrow \mathrm{imm}$ |  |  |  |  |  |  |  |  | $\checkmark$ | - |
|  | Register indirect jump | JMP dp | $\mathrm{PC} \leftarrow \mathrm{dp}$ |  |  |  |  |  |  |  |  | $\checkmark$ | - |
|  | Subroutine call | CALL imm | $\begin{aligned} & \mathrm{SP} \leftarrow \mathrm{SP}+1 \\ & \mathrm{STK} \leftarrow \mathrm{PC}+1 \\ & \mathrm{PC} \leftarrow \mathrm{imm} \end{aligned}$ |  |  |  |  |  |  |  |  | $\checkmark$ | $\bullet$ |
|  | Register <br> indirect <br> subroutine call | CALL dp | $\begin{aligned} & \mathrm{SP} \leftarrow \mathrm{SP}+1 \\ & \mathrm{STK} \leftarrow \mathrm{PC}+1 \\ & \mathrm{PC} \leftarrow \mathrm{dp} \end{aligned}$ |  |  |  |  |  |  |  |  | $\checkmark$ | $\bullet$ |
|  | Return | RET | $\begin{aligned} & \mathrm{PC} \leftarrow \mathrm{STK} \\ & \mathrm{SP} \leftarrow \mathrm{SP}-1 \end{aligned}$ |  |  |  |  |  |  |  |  | $\checkmark$ | $\bullet$ |
|  | Interrupt return | RETI | $\begin{aligned} & \mathrm{PC} \leftarrow \mathrm{STK} \\ & \mathrm{STK} \leftarrow \mathrm{SP}-1 \end{aligned}$ <br> Recovery of interrupt enable flag |  |  |  |  |  |  |  |  | $\checkmark$ | $\bullet$ |
| Hard- <br> ware loop | Repeat | REP count | Start $\mathrm{RC} \leftarrow$ count <br>  $\mathrm{RF} \leftarrow 0$ <br> During repeat $\mathrm{PC} \leftarrow \mathrm{PC}$ <br>  $\mathrm{RC} \leftarrow \mathrm{RC}-1$ <br> End $\mathrm{PC} \leftarrow \mathrm{PC}+1$ <br>  $\mathrm{RF} \leftarrow 1$ |  |  |  |  |  |  |  |  |  | $\bullet$ |
|  | Loop | LOOP count (instruction of two or more lines) | Start $R C \leftarrow$ count <br>  $R F \leftarrow 0$ <br> During repeat $P C \leftarrow P C$ <br>  $R C \leftarrow R C-1$ <br> End $P C \leftarrow P C+1$ <br>  $R F \leftarrow 1$ |  |  |  |  |  |  |  |  |  | - |
|  | Loop pop | LPOP | $\begin{aligned} & \mathrm{LC} \leftarrow \text { LSR3 } \\ & \mathrm{LE} \leftarrow \text { LSR2 } \\ & \text { LS } \leftarrow \text { LSR1 } \\ & \text { LSP } \leftarrow \text { LSP - } \end{aligned}$ |  |  |  |  |  |  |  |  |  | $\bullet$ |
| Control | No operation | NOP | $\mathrm{PC} \leftarrow \mathrm{PC}+1$ |  |  |  |  |  |  |  |  |  | - |
|  | Halt | HALT | CPU stops. |  |  |  |  |  |  |  |  |  | $\bullet$ |
|  | Stop | STOP | CPU, PLL, and OSC stop |  |  |  |  |  |  |  |  |  | $\bullet$ |
|  | Condition | IF (ro cond) | Condition test |  |  | $\checkmark$ |  | $\sqrt{ }$ |  | $\checkmark$ |  |  | $\bullet$ |
|  | Forget interrupt | FINT | Discard interrupt request |  |  |  |  |  |  |  |  |  | $\bullet$ |

## 8. ELECTRICAL SPECIFICATIONS

## Absolute Maximum Ratings ( $\mathrm{T}_{\mathrm{A}}=\boldsymbol{+ 2 5 ^ { \circ }} \mathbf{C}$ )

| Parameter | Symbol | Condition | Rating | Unit |
| :--- | :---: | :--- | :--- | :---: |
| Supply voltage | $\mathrm{I} \mathrm{V}_{\mathrm{DD}}$ | For DSP core | -0.5 to +3.6 | V |
|  | $\mathrm{EV}_{\mathrm{DD}}$ | For I/O pins | -0.5 to +4.6 | V |
| Input voltage | $\mathrm{V}_{1}$ | $\mathrm{~V}_{1}<\mathrm{EVDD}+0.5 \mathrm{~V}$ | -0.5 to +4.1 | V |
| Output voltage | $\mathrm{V}_{\mathrm{o}}$ |  | -0.5 to +4.1 | V |
| Storage temperature | $\mathrm{T}_{\mathrm{stg}}$ |  | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Operating ambient <br> temperature | $\mathrm{T}_{\mathrm{A}}$ |  | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |

Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

Recommended Operating Conditions

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :--- | :---: | :--- | :---: | :---: | :---: | :---: |
| Operating voltage | IVDD | For DSP core | 2.0 |  | 2.7 | V |
|  | EVDD | For I/O pins | 2.7 |  | 3.6 | V |
| Input voltage | $\mathrm{V}_{\mathrm{I}}$ |  | 0 |  | EVDD | V |

Capacitance $\left(\mathrm{T}_{\mathrm{A}}=+\mathbf{2 5}{ }^{\circ} \mathrm{C}, \mathrm{IV} \mathrm{DD}=0 \mathrm{~V}, \mathrm{EV}_{\mathrm{DD}}=0 \mathrm{~V}\right)$

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :--- | :---: | :--- | :---: | :---: | :---: | :---: |
| Input capacitance | $\mathrm{C}_{\mathrm{I}}$ | $\mathrm{f}=1 \mathrm{MHz}$, |  |  |  |  |
| Pins other than those |  |  |  |  |  |  |
| Output capacitance | Co |  | 10 |  | pF |  |
|  | tested: 0 V |  |  |  |  |  |

DC Characteristics (Unless otherwise specified, $T_{A}=-40$ to $+85^{\circ} \mathrm{C}$, with $\operatorname{IVDD}$ and EVDD within recommended operating condition range)

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| High-level input voltage | VIHN | Pins other than below | 0.7 EVDD |  | EVDD | V |
|  | $\mathrm{V}_{\mathrm{HSS}}$ | $\overline{\mathrm{RESET}}, \overline{\mathrm{INT} 1}$ to $\overline{\mathrm{NT} 4}$, SCK, SIEN, SOEN | 0.8 EVDD |  | EVDD | V |
|  | V ${ }_{\text {HC }}$ | CLKIN | $\begin{gathered} 0.5 \mathrm{EV} \mathrm{VDD}^{2} \\ +0.25 \end{gathered}$ |  | $E V_{\text {do }}$ | V |
| Low-level input voltage | VIL | Pins other than below | 0 |  | $0.2 \mathrm{EV} \mathrm{DD}^{\text {d }}$ | V |
|  | Vic | CLKIN | 0 |  | $\begin{gathered} 0.5 \text { EVDD } \\ -0.25 \end{gathered}$ | V |
| High-level output voltage | Vон | $\mathrm{IOH}=-2.0 \mathrm{~mA}$ | 0.7 EVDD |  |  | V |
|  |  | $\mathrm{IOH}=-100 \mu \mathrm{~A}$ | 0.8 EVDD |  |  | V |
| Low-level output voltage | VoL | $\mathrm{loL}=2.0 \mathrm{~mA}$ |  |  | 0.2 EV DD | V |
| High-level input leakage current | ILH | Other than TDI, TMS, and $\overline{\text { TRST }}$ $\mathrm{V}_{1}=E V_{D D}$ | 0 |  | 10 | $\mu \mathrm{A}$ |
| Low-level input leakage current | ILL | Other than TDI, TMS, and TRST $\mathrm{V}_{\mathrm{I}}=0 \mathrm{~V}$ | -10 |  | 0 | $\mu \mathrm{A}$ |
| Pull-up pin current | IpuI | TDI, TMS, $0 \mathrm{~V} \leq \mathrm{V}_{1} \leq \mathrm{EV}_{\text {DD }}$ | -250 |  | 0 | $\mu \mathrm{A}$ |
| Pull-down pin current | Ipol | $\overline{\text { TRST, }} 0 \mathrm{~V} \leq \mathrm{V}_{1} \leq \mathrm{EV}$ DD | 0 |  | 250 | $\mu \mathrm{A}$ |
| Internal supply current $\left[V_{I H N}=V_{I H S}=E V_{D D}, V_{I L}=0 \mathrm{~V},\right.$ <br> no load] | $1 \mathrm{ldo}^{\text {Note }}$ | During operating, $30 \mathrm{~ns}, \mathrm{IV} \mathrm{DD}=$ 2.7 V |  | TBD | 75 | mA |
|  | IdDH | In halt mode, tcc $=30 \mathrm{~ns}$, divided by eight, $\mathrm{IV} \mathrm{VD}=2.7 \mathrm{~V}$ |  | TBD | 10 | mA |
|  | IdDs | In stop mode, $0^{\circ} \mathrm{C}<\mathrm{T}_{\text {A }}<60^{\circ} \mathrm{C}$ |  |  | 100 | $\mu \mathrm{A}$ |

Note The TYP. values are when an ordinary program is executed.
The MAX. values are when a special program that brings about frequent switching inside the device is executed.

## Common Test Criteria of Switching Characteristics



AC Characteristics ( $\mathrm{T}_{\mathrm{A}}=-\mathbf{4 0}$ to $+\mathbf{8 5}{ }^{\circ} \mathrm{C}$, with IVDD and $E V_{D D}$ within recommended operating condition range)

## Clock

Timing requirements

| Parameter | Symbol | Condition |  | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CLKIN cycle time ${ }^{\text {Note } 1}$ | tccx |  |  | 25 |  |  | ns |
|  |  | PLL lock range ${ }^{\text {Note } 2}$ | $\begin{aligned} & \mathrm{IV} \mathrm{DD}=2.0 \\ & \text { to } 2.7 \mathrm{~V} \end{aligned}$ | $15 \times \mathrm{m}$ |  | $50 \times \mathrm{m}$ | ns |
|  |  |  | $\begin{aligned} & \mathrm{IV} \mathrm{VD}=2.3 \\ & \text { to } 2.7 \mathrm{~V} \end{aligned}$ | $10 \times m$ |  | $50 \times \mathrm{m}$ | ns |
| CLKIN high-level width | twCXH |  |  | 12.5 |  |  | ns |
| CLKIN low-level width | twCxL |  |  | 12.5 |  |  | ns |
| CLKIN rise/fall time | tricx |  |  |  |  | 5 | ns |
| Internal clock cycle time requirements ${ }^{\text {Note } 3}$ | tcC (R) | IVdd $=2.0$ to 2.7 V |  | 20 |  |  | ns |
|  |  | $\mathrm{IV} \mathrm{DD}=2.3$ to 2.7 V |  | 13.3 |  |  | ns |

Notes 1. m: Multiple
2. This is the range in which the PLL is locked (stably oscillates). Input tccx within this range.
3. Input $t_{c c x}$ so that the value of $\left(\mathrm{t}_{\mathrm{c}} \mathrm{cx} \div \mathrm{m} \times \mathrm{n}\right)$ satisfies this condition. m : Multiple, n : Division ratio

## Switching characteristics

| Parameter | Symbol | Condition |  | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Internal clock cycle ${ }^{\text {Note }}$ | $t_{c c}$ | External clock operation |  |  | tccx |  | ns |
|  |  | PLL clock operation |  |  | $(\mathrm{tccx} \div \mathrm{m}) \times \mathrm{n}$ |  | ns |
|  |  | In HALT mode |  |  | $(\operatorname{tcc} x \div m) \times n \times 1$ |  | ns |
| CLKOUT cycle time | tcco |  |  |  | tcc |  | ns |
| CLKOUT width | twco | During normal operation | $n=1$, or even number | tcc $\div 2-3$ |  |  | ns |
|  |  |  | n = odd number <br> (other than 1) | $\mathrm{tcc}_{\mathrm{c}} \div \mathrm{n}-3$ |  |  | ns |
|  |  | In HALT mode |  | $\mathrm{tcc} \div \mathrm{n}-3$ |  |  | ns |
| CLKOUT rise/fall time | trico |  |  |  |  | 5 | ns |
| CLKOUT delay time | tdco | $\mathrm{IV} \mathrm{DD}=2.0$ to 2.7 V |  |  |  | 20 | ns |
|  |  | IV DD $=2.3$ to 2.7 V |  |  |  | 15 | ns |

Note m: Multiple, n: Division ratio, l: HALT division ratio

## Clock I/O timing



## Reset, Interrupt

Timing requirements

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\overline{\text { RESET }}$ low-level width | tw (RL) |  | $6 \mathrm{tcc}^{\text {Note }}$ |  |  | ns |
| WAKEUP low-level width | tw (WAKEUPL) |  | 6 toc |  |  | $\mu \mathrm{s}$ |
| $\overline{\mathrm{INT} 1}$ to INT4 low-level width | tw (INTL) |  | $3 \mathrm{tcc}^{\text {Note }}$ |  |  | ns |
| $\overline{\mathrm{INT} 1}$ to $\overline{\mathrm{INT} 4}$ recovery time | trec (INT) |  | 3 tcc |  |  | ns |

Note Note that tcc is I $(I=$ integer of 1 to 16$)$ times that during normal operation in the HALT mode.

## Reset timing



## WAKEUP timing



Interrupt timing
$\overline{\mathrm{INT} 1}$ to $\overline{\mathrm{INT} 4}$


## Serial Interface (Audio Serial mode)

## Timing requirements

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| MCLK cycle time | tomc | Master mode | 40 |  |  | ns |
| MCLK high-/low-level width | twMc | Master mode | $0.4 \times \mathrm{tcmc}$ |  |  | ns |
| MCLK rise/fall time | trimc | Master mode |  |  | Note | ns |
| BCLK cycle time | tcbe | Slave mode | 300 |  |  | ns |
| BCLK high-/low-level width | $t_{\text {wBC }}$ | Slave mode | 120 |  |  | ns |
| BCLK rise/fall time | tribc | Slave mode |  |  | 20 | ns |
| LRCLK setup time | tsu(BC-LR) | Slave mode | 50 |  |  | ns |
| SI setup time | tsus |  | 50 |  |  | ns |
| SI hold time | thsi |  | 50 |  |  | ns |

Note 5 or maximum value of $0.1 \times \mathrm{tcmc}$

## Switching characteristics

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| BCLK cycle time | $\mathrm{tc}_{\mathrm{cBC}}$ | Master mode, 64-bit mode |  | 1/64 fs |  | ns |
|  |  | Master mode, 32-bit mode |  | 1/32 fs |  | $n \mathrm{~s}$ |
| BCLK high-/low-level width | $t_{\text {wBC }}$ | Master mode | $0.4 \mathrm{tcBC}^{\text {c }}$ |  |  | ns |
| BCLK rise/fall time | tribc | Master mode |  |  | 20 | ns |
| LRCLK delay time | td(BC-LR) | Master mode | -40 |  | +40 | ns |
| SO output delay time | tdso |  | -40 |  | +40 | ns |

## Audio Serial clock timing



## Audio Serial Master mode timing



## Audio Serial Slave mode timing



## Serial Interface (Standard Serial mode)

## Timing requirements

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SCK cycle time | tosc |  | 60 and 2tcc |  |  | ns |
| SCK high-/low-level width | twsc |  | 25 |  |  | ns |
| SCK rise/fall time | trisc |  |  |  | 20 | ns |
| SOEN setup time | tsusoe | IVDD $=2.0$ to 2.7 V | 10 |  |  | ns |
|  |  | IVDD $=2.3$ to 2.7 V | 5 |  |  | ns |
| SOEN hold time | thsoe | IVDD $=2.0$ to 2.7 V | 15 |  |  | ns |
|  |  | IVDD $=2.3$ to 2.7 V | 10 |  |  | ns |
| SIEN setup time | tsusie | IVDD $=2.0$ to 2.7 V | 10 |  |  | ns |
|  |  | IVDD $=2.3$ to 2.7 V | 5 |  |  | ns |
| SIEN hold time | tnsIE | IVDD $=2.0$ to 2.7 V | 15 |  |  | ns |
|  |  | IVDD $=2.3$ to 2.7 V | 10 |  |  | ns |
| SI setup time | tsusı | IVDD $=2.0$ to 2.7 V | 10 |  |  | ns |
|  |  | IVDD $=2.3$ to 2.7 V | 5 |  |  | ns |
| SI hold time | thsi | IVDD $=2.0$ to 2.7 V | 15 |  |  | ns |
|  |  | IVDD $=2.3$ to 2.7 V | 10 |  |  | ns |

## Switching characteristics

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| SO output delay time | taso | IV DD $=2.0$ to 2.7 V |  |  | 30 | ns |
|  |  | $\mathrm{IVDD}=2.3$ to 2.7 V |  |  | 25 | ns |
| SO hold time | thso |  | 0 |  | ns |  |

## Serial output timing 1



Serial output timing 2 (during successive output)


## Serial input timing 1



Serial input timing 2 (during successive input)


Caution If noise is superimposed on the serial clock, the serial interface may be deadlocked. Bear in mind the following points when designing your system:

- Reinforce the wiring for power supply and ground (if noise is superimposed on the power and ground lines, it has the same effect as if noise were superimposed on the serial clock).
- Shorten the wiring between the device's SCK pin, and clock supply source.
- Do not cross the signal lines of the serial clock with any other signal lines. Do not route the serial clock line in the vicinity of a line through which a high alternating current flows.
- Supply the clock to the SCK pin of the device from the clock source on a one-to-one basis. Do not supply clock to several devices from one clock source.
- Exercise care that the serial clock does not overshoot or undershoot. In particular, make sure that the rising and falling of the serial clock waveform are clear.



## Host Interface

## Timing requirements

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\overline{\mathrm{HRD}}$ delay time | tdHR | $\mathrm{IV} \mathrm{DD}=2.0$ to 2.7 V | 15 |  |  | ns |
|  |  | $\mathrm{IV} \mathrm{DD}=2.3$ to 2.7 V | 5 |  |  | ns |
| $\overline{\mathrm{HRD}}$ width | twHR |  | 40 |  |  | ns |
| $\overline{\mathrm{HCS}}, \mathrm{HAO}, \mathrm{HA} 1$, read hold time | thHCAR |  | 0 |  |  | ns |
| $\overline{\mathrm{HCS}}, \mathrm{HAO}, \mathrm{HA} 1$ write hold time | thHCAW |  | 0 |  |  | $n s$ |
| HRD, HWR recovery time | trechs |  | $3 \mathrm{tcc}_{\text {c }}$ |  |  | ns |
| HWR delay time | tdrw | IV DD $=2.0$ to 2.7 V | 15 |  |  | ns |
|  |  | $\mathrm{IV} \mathrm{DD}=2.3$ to 2.7 V | 10 |  |  | ns |
| $\overline{\mathrm{HWR}}$ width | twHw |  | 40 |  |  | ns |
| $\overline{\text { HWR }}$ hold time | thHDW |  | 0 |  |  | ns |
| HWR setup time | tsuHDw | IV DD $=2.0$ to 2.7 V | 15 |  |  | ns |
|  |  | $\mathrm{IV} \mathrm{DD}=2.3$ to 2.7 V | 10 |  |  | ns |

## Switching characteristics

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| HRE, HWE output delay time | tdHE | $\mathrm{IV} \mathrm{DD}=2.0$ to 2.7 V |  |  | 30 | ns |
|  |  | $\mathrm{IV} \mathrm{DD}=2.3$ to 2.7 V |  |  | 25 | ns |
| HRE, HWE hold time | thHE | $\mathrm{IV} \mathrm{DD}=2.0$ to 2.7 V |  |  | 30 | ns |
|  |  | IVDD $=2.3$ to 2.7 V |  |  | 25 | ns |
| HRD valid time | twhid | IV $\mathrm{DD}^{\text {a }} 2.0$ to 2.7 V |  |  | 30 | ns |
|  |  | $\mathrm{IV} \mathrm{DD}=2.3$ to 2.7 V |  |  | 25 | ns |
| $\overline{\text { HRD }}$ hold time | thHor |  | 0 |  |  | ns |

## Host read interface timing



Host write interface timing


## General-purpose I/O Port

Timing requirements

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Port input setup time | tsuPI |  | 0 |  |  | ns |
| Port input hold time | thPI | IV DD $=2.0$ to 2.7 V | 15 |  |  | ns |
|  |  | $\mathrm{IVDD}=2.3$ to 2.7 V | 10 |  |  | ns |

## Switching characteristics

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Port output delay time | taPo | $\mathrm{IVDD}=2.0$ to 2.7 V |  |  | 30 |
|  |  | $I V_{D D}=2.3$ to 2.7 V |  | ns |  |

## General-purpose I/O port timing



## SD card Interface

Timing requirements

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SDCR input setup time | tsuSDCR | Input Response | 5 |  |  | $n s$ |
| SDCR input hold time | thsDCR | Input Response | 0 |  |  | ns |
| SDDAT input setup time | tsuSDD | Input data | 5 |  |  | ns |
| SDDAT input hold time | thSDD | Input data | 0 |  |  | ns |

## Switching characteristics

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SDCLK cycle time | tcsbc |  | 40 |  |  | ns |
| SDCLK high- level width | twSDCH |  | 10 |  |  | ns |
| SDCLK low-level width | twSDCL |  | 10 |  |  | ns |
| SDCLK rise/fall time | trisdc |  |  |  | 10 | ns |
| SDCR output delay time | tdSDCR | Output Command |  |  | 10 | ns |
| SDCR output valid time | tvsDCR | Output Command | 0 |  |  | ns |
| SDDAT output delay time | tdSDD | Output data |  |  | 10 | ns |
| SDDAT output valid time | tvSDD | Output data | 0 |  |  | ns |

SDCR timing


SDDAT timing


## Debugging Interface (JTAG)

Timing requirements

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TCK cycle time | tctck |  | 120 |  |  | ns |
| TCK high-/low-level width | twTCK |  | 50 |  |  | ns |
| TCK rise/fall time | trick |  |  |  | 20 | ns |
| TMS, TDI setup time | tsuDI | $\mathrm{IV} \mathrm{DD}=2.0$ to 2.7 V | 25 |  |  | ns |
|  |  | $\mathrm{IV} \mathrm{DD}=2.3$ to 2.7 V | 20 |  |  | ns |
| TMS, TDI hold time | thDI | $\mathrm{IV} \mathrm{DD}=2.0$ to 2.7 V | 25 |  |  | ns |
|  |  | $\mathrm{IV} \mathrm{DD}=2.3$ to 2.7 V | 20 |  |  | ns |
| Input pin setup time | tsulin | $1 \mathrm{~V}_{\text {DD }}=2.0$ to 2.7 V | 25 |  |  | ns |
|  |  | $\mathrm{IV} \mathrm{DD}=2.3$ to 2.7 V | 20 |  |  | ns |
| Input pin hold time | thuln | IV DD $=2.0$ to 2.7 V | 25 |  |  | ns |
|  |  | $\mathrm{IV} \mathrm{DD}=2.3$ to 2.7 V | 20 |  |  | ns |
| $\overline{\text { TRST }}$ setup time | tsutrst |  | 100 |  |  | ns |

## Switching characteristics

| Parameter | Symbol | Condition | MIN. | TYP. | MAX. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TDO output delay time | tado | $\mathrm{IV} \mathrm{DD}=2.0$ to 2.7 V |  |  | 25 | ns |
|  |  | $\mathrm{IV} \mathrm{VD}=2.3$ to 2.7 V |  |  | 20 | ns |
| Output pin output delay time | tajout | IV DD $=2.0$ to 2.7 V |  |  | 25 | ns |
|  |  | $\mathrm{IV} \mathrm{DD}=2.3$ to 2.7 V |  |  | 20 | ns |

## Debugging interface timing



Remark For details of JTAG, refer to IEEE1149.1.

## 9. PACKAGES

## $\star \quad$ 80-PIN PLASTIC FBGA (9x9)



|  | $($ UNIT:mm $)$ |
| :---: | :--- |
| ITEM | DIMENSIONS |
| D | $9.00 \pm 0.10$ |
| $E$ | $9.00 \pm 0.10$ |
| $w$ | 0.20 |
| $A$ | $1.28 \pm 0.10$ |
| A1 | $0.35 \pm 0.06$ |
| A2 | 0.93 |
| e | 0.80 |
| $b$ | $0.50_{-0.10}^{+0.05}$ |
| $x$ | 0.08 |
| $y$ | 0.10 |
| $y 1$ | 0.20 |
| ZD | 1.30 |
| ZE | 1.30 |
|  | P80F1-80-CN6 |

## 80-PIN PLASTIC TQFP (FINE PITCH) (12x12)


detail of lead end


NOTE
Each lead centerline is located within 0.10 mm of its true position (T.P.) at maximum material condition.

| ITEM | MILLIMETERS |
| :---: | :--- |
| A | $14.0 \pm 0.2$ |
| B | $12.0 \pm 0.2$ |
| C | $12.0 \pm 0.2$ |
| D | $14.0 \pm 0.2$ |
| F | 1.25 |
| G | 1.25 |
| H | $0.22 \pm 0.05$ |
| I | 0.10 |
| J | 0.5 (T.P.) |
| K | $1.0 \pm 0.2$ |
| L | $0.5 \pm 0.2$ |
| M | $0.145 \pm 0.05$ |
| N | 0.10 |
| P | $1.0 \pm 0.05$ |
| Q | $0.1 \pm 0.05$ |
| R | $3_{-3}^{\circ+7^{\circ}}$ |
| S | 1.2 MAX. |
|  | S80GK-50-9EU-1 |

## 10. RECOMMENDED SOLDERING CONDITIONS

It is recommended to solder this product under the following conditions.
For soldering methods and conditions other than those recommended below, contact an NEC Electronics sales representative.

For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

## Surface-Mount Type

- $\mu$ PD77115GK-9EU: 80-pin plastic TQFP (fine-pitch) $(12 \times 12)$

| Soldering Process | Soldering Conditions | Symbol |
| :--- | :--- | :---: |
| Infrared ray reflow | Package peak temperature: $235^{\circ} \mathrm{C}$, Time: 30 seconds MAX $\left(210^{\circ} \mathrm{C} \mathrm{MIN}\right)$, <br> Number of times: 2 MAX, Number of days: $3^{\text {Note }}$ (after that, prebaking is necessary <br> for 10 to 72 hours at $\left.125^{\circ} \mathrm{C}\right)$ ) | IR35-103-2 |
| VPS | Package peak temperature: $215^{\circ} \mathrm{C}$, Time: 40 seconds MAX $\left(200^{\circ} \mathrm{C} \mathrm{MIN)}\right.$, <br> Number of times: 2 MAX, Number of days: $3^{\text {Note }}$ (after that, prebaking isnecessary <br> for 10 to 72 hours at $125^{\circ} \mathrm{C}$ ) | VP15-103-2 |
| Partial heating method | Pin temperature: $300^{\circ} \mathrm{C}$ MAX, Time: 3 seconds MAX (per side of device) | - |

- $\mu$ PD77115F1-CN6: 80-pin plastic FBGA $(9 \times 9)$
- $\mu$ PD77115AF1-xxx-CN6: 80-pin plastic FBGA $(9 \times 9)$

| Soldering Process | Soldering Conditions | Symbol |
| :--- | :--- | :---: |
| Infrared ray reflow | Package peak temperature: $235^{\circ} \mathrm{C}$, Time: 30 seconds MAX $\left(210^{\circ} \mathrm{C} \mathrm{MIN}\right)$, <br> Number of times: 2 MAX, Number of days: $3^{\text {Note }}$ (after that, prebaking is necessary <br> for 10 to 72 hours at $\left.125^{\circ} \mathrm{C}\right)$ ) | IR35-103-2 |
| VPS | Package peak temperature: $215^{\circ} \mathrm{C}$, Time: 40 seconds MAX $\left(200^{\circ} \mathrm{C} \mathrm{MIN)}\right.$, <br> Number of times: 2 MAX, Number of days: $3^{\text {Note }}$ (after that, prebaking isnecessary <br> for 10 to 72 hours at $125^{\circ} \mathrm{C}$ ) | VP15-103-2 |

Note Number of days in storage after the dry pack has been opened. The storage conditions are at $25^{\circ} \mathrm{C}, 65 \%$ RH MAX.

## Caution Apply wave soldering only to the pins and be careful not to bring solder into direct contact with the package.

## Regional Information

Some information contained in this document may vary from country to country. Before using any NEC Electronics product in your application, please contact the NEC Electronics office in your country to obtain a list of authorized representatives and distributors. They will verify:

- Device availability
- Ordering information
- Product release schedule
- Availability of related technical literature
- Development environment specifications (for example, specifications for third-party tools and components, host computers, power plugs, AC supply voltages, and so forth)
- Network requirements

In addition, trademarks, registered trademarks, export restrictions, and other legal issues may also vary from country to country.

## [GLOBAL SUPPORT]

http://www.necel.com/en/support/support.html

NEC Electronics America, Inc. (U.S.) NEC Electronics (Europe) GmbH
Santa Clara, California
Tel: 408-588-6000
800-366-9782
Duesseldorf, Germany
Tel: 0211-65030

- Sucursal en España

Madrid, Spain
Tel: 091-504 2787

- Succursale Française

Vélizy-Villacoublay, France
Tel: 01-30-675800

- Filiale Italiana

Milano, Italy
Tel: 02-66 7541

- Branch The Netherlands

Eindhoven, The Netherlands
Tel: 040-2445845

- Tyskland Filial

Taeby, Sweden
Tel: 08-63 80820

- United Kingdom Branch

Milton Keynes, UK
Tel: 01908-691-133

NEC Electronics Hong Kong Ltd.
Hong Kong
Tel: 2886-9318
NEC Electronics Hong Kong Ltd.
Seoul Branch
Seoul, Korea
Tel: 02-558-3737
NEC Electronics Shanghai Ltd.
Shanghai, P.R. China
Tel: 021-5888-5400
NEC Electronics Taiwan Ltd.
Taipei, Taiwan
Tel: 02-2719-2377
NEC Electronics Singapore Pte. Ltd. Novena Square, Singapore
Tel: 6253-8311

## NOTES FOR CMOS DEVICES

## (1) VOLTAGE APPLICATION WAVEFORM AT INPUT PIN

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between VIL (MAX) and Vін (MIN) due to noise, etc., the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between VIL (MAX) and $\mathrm{V}_{\mathrm{IH}}$ (MIN).

## (2) HANDLING OF UNUSED INPUT PINS

Unconnected CMOS device inputs can be cause of malfunction. If an input pin is unconnected, it is possible that an internal input level may be generated due to noise, etc., causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using pull-up or pull-down circuitry. Each unused pin should be connected to VDD or GND via a resistor if there is a possibility that it will be an output pin. All handling related to unused pins must be judged separately for each device and according to related specifications governing the device.

## (3) PRECAUTION AGAINST ESD

A strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it when it has occurred. Environmental control must be adequate. When it is dry, a humidifier should be used. It is recommended to avoid using insulators that easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors should be grounded. The operator should be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with mounted semiconductor devices.

## (4) STATUS BEFORE INITIALIZATION

Power-on does not necessarily define the initial status of a MOS device. Immediately after the power source is turned ON, devices with reset functions have not yet been initialized. Hence, power-on does not guarantee output pin levels, I/O settings or contents of registers. A device is not initialized until the reset signal is received. A reset operation must be executed immediately after power-on for devices with reset functions.

## POWER ON/OFF SEQUENCE

In the case of a device that uses different power supplies for the internal operation and external interface, as a rule, switch on the external power supply after switching on the internal power supply. When switching the power supply off, as a rule, switch off the external power supply and then the internal power supply. Use of the reverse power on/off sequences may result in the application of an overvoltage to the internal elements of the device, causing malfunction and degradation of internal elements due to the passage of an abnormal current.
The correct power on/off sequence must be judged separately for each device and according to related specifications governing the device.

## (6) INPUT OF SIGNAL DURING POWER OFF STATE

Do not input signals or an I/O pull-up power supply while the device is not powered. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Input of signals during the power off state must be judged separately for each device and according to related specifications governing the device.

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